

M63814P/FP/GP/KP

7-UNIT 300mA TRANSISTOR ARRAY WITH CLAMP DIODE

DESCRIPTION

M63814P/FP/GP/KP are seven-circuit Single transistor arrays with clamping diodes. The circuits are made of NPN transistors. Both the semiconductor integrated circuits perform high-current driving with extremely low input-current supply.

FEATURES

- Four package configurations (P, FP, GP and KP)
- Medium breakdown voltage ($BV_{CEO} \geq 35V$)
- Synchronizing current ($I_{C(max)} = 300mA$)
- With clamping diodes
- Low output saturation voltage
- Wide operating temperature range ($T_a = -40$ to $+85^\circ C$)

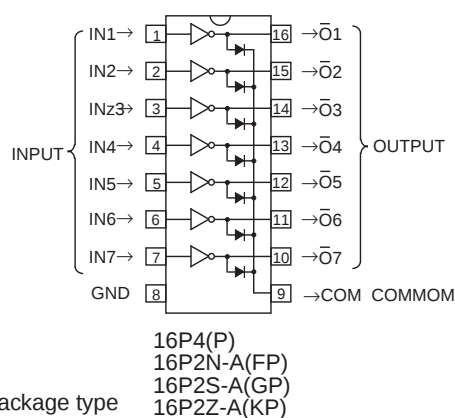
APPLICATION

Driving of digit drives of indication elements (LEDs and lamps) with small signals

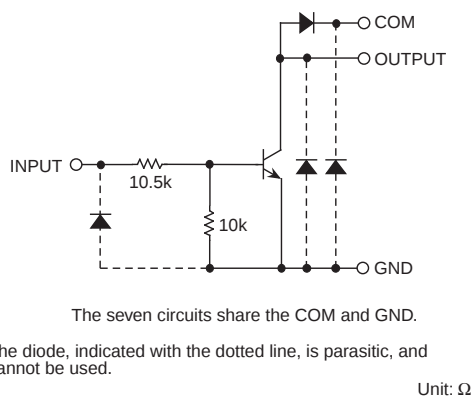
FUNCTION

The M63814P/FP/GP/KP each have seven circuits consisting of NPN transistor. A spike-killer clamping diode is provided between each output pin (collector) and COM pin (pin9). The transistor emitters are all connected to the GND pin (pin 8). The transistors allow synchronous flow of 300mA collector current. A maximum of 35V voltage can be applied between the collector and emitter.

PIN CONFIGURATION



CIRCUIT DIAGRAM



ABSOLUTE MAXIMUM RATINGS (Unless otherwise noted, $T_a = -40 \sim +85^\circ C$)

Symbol	Parameter	Conditions	Ratings	Unit
V_{CEO}	Collector-emitter voltage	Output, H	$-0.5 \sim +35$	V
I_C	Collector current	Current per circuit output, L	300	mA
V_i	Input voltage		$-0.5 \sim +35$	V
I_F	Clamping diode forward current		300	mA
V_R	Clamping diode reverse voltage		35	V
P_d	Power dissipation	$T_a = 25^\circ C$, when mounted on board	M63814P	1.47
			M63814FP	1.00
			M63814GP	0.80
			M63814KP	0.78
T_{opr}	Operating temperature		$-40 \sim +85$	$^\circ C$
T_{stg}	Storage temperature		$-55 \sim +125$	$^\circ C$

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RECOMMENDED OPERATING CONDITIONS (Unless otherwise noted, Ta = -40 ~ +85°C)

Symbol	Parameter		Test conditions	Limits			Unit
				min	typ	max	
Vo	Output voltage			0	—	35	V
Ic	Collector current (Current per 1 circuit when 7 circuits are coming on simultaneously)	M63814P	Duty Cycle no more than 45%	0	—	250	mA
			Duty Cycle no more than 100%	0	—	160	
		M63814FP	Duty Cycle no more than 30%	0	—	250	
			Duty Cycle no more than 100%	0	—	130	
		M63814GP	Duty Cycle no more than 24%	0	—	250	
			Duty Cycle no more than 100%	0	—	120	
		M63814KP	Duty Cycle no more than 24%	0	—	250	
			Duty Cycle no more than 100%	0	—	120	
VIN	Input voltage			0	—	30	V

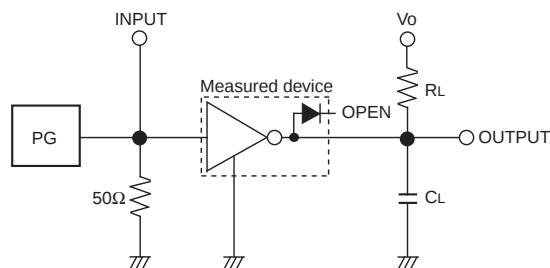
ELECTRICAL CHARACTERISTICS (Unless otherwise noted, Ta = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			min	typ	max	
V (BR) CEO	Collector-emitter breakdown voltage	ICEO = 10μA	35	—	—	V
VCE(sat)	Collector-emitter saturation voltage	IIN = 1mA, IC = 10mA	—	—	0.2	V
		IIN = 2mA, IC = 150mA	—	—	0.8	
VIN(on)	"On" input voltage	IIN = 1mA, IC = 10mA	7.5	11.0	15.0	V
VF	Clamping diode forward voltage	IF = 250mA	—	1.2	2.0	V
IR	Clamping diode reverse current	VR = 35V	—	—	10	μA
hFE	DC amplification factor	VCE = 10V, IC = 10mA	50	—	—	—

SWITCHING CHARACTERISTICS (Unless otherwise noted, Ta = 25°C)

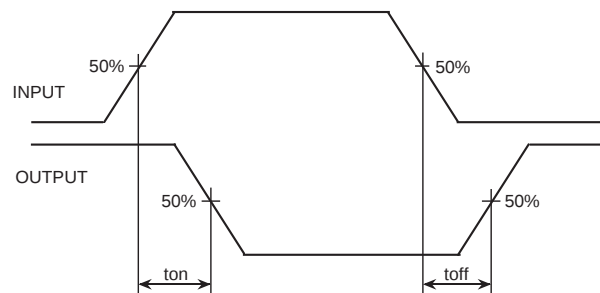
Symbol	Parameter	Test conditions	Limits			Unit
			min	typ	max	
ton	Turn-on time	CL = 15pF (note 1)	—	120	—	ns
toff	Turn-off time		—	240	—	ns

NOTE 1 TEST CIRCUIT



- (1) Pulse generator (PG) characteristics : PRR = 1kHz, tw = 10μs, tr = 6ns, tf = 6ns, Zo = 50Ω, VIH = 11V
- (2) Input-output conditions : RL = 220Ω, Vo = 35V
- (3) Electrostatic capacity CL includes floating capacitance at connections and input capacitance at probes

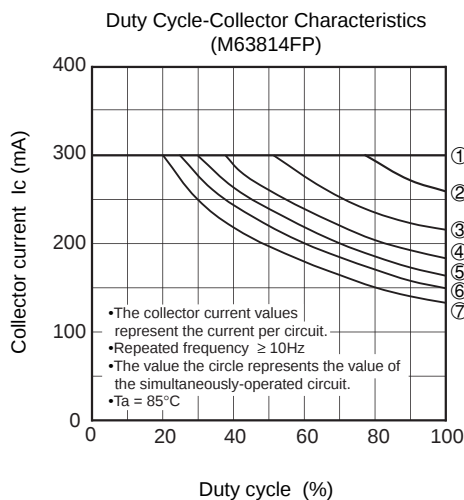
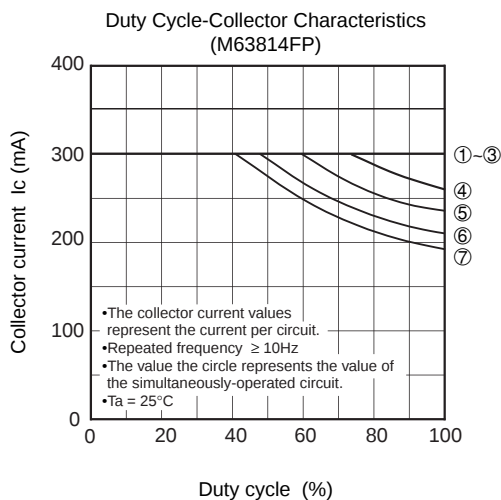
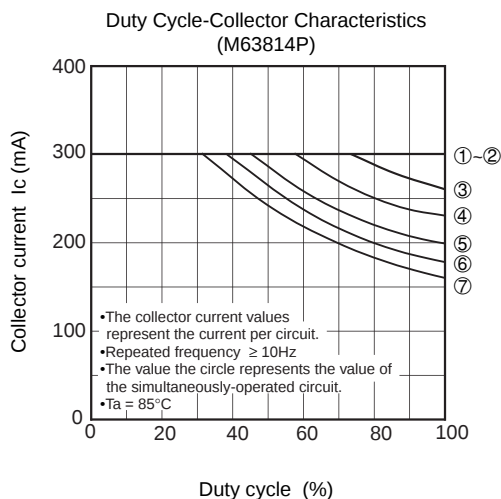
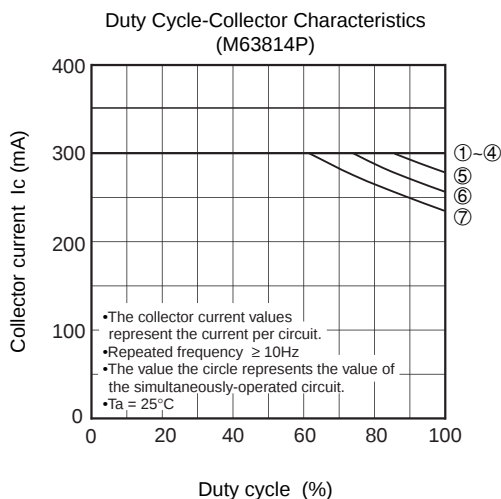
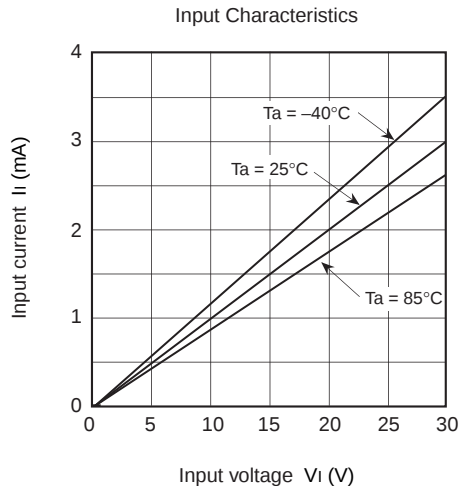
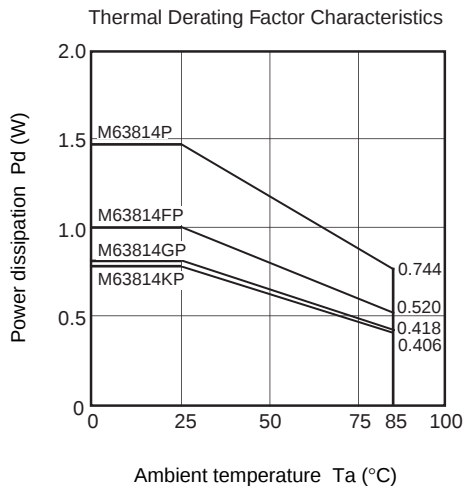
TIMING DIAGRAM



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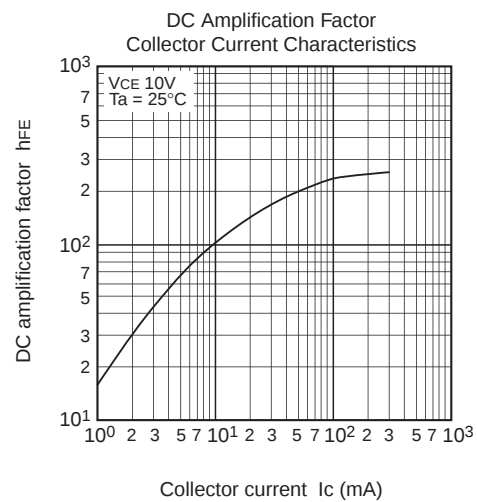
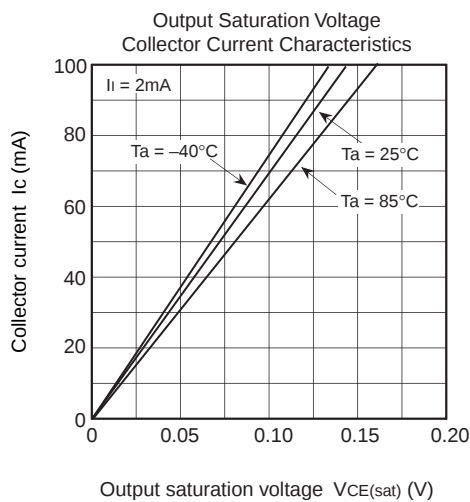
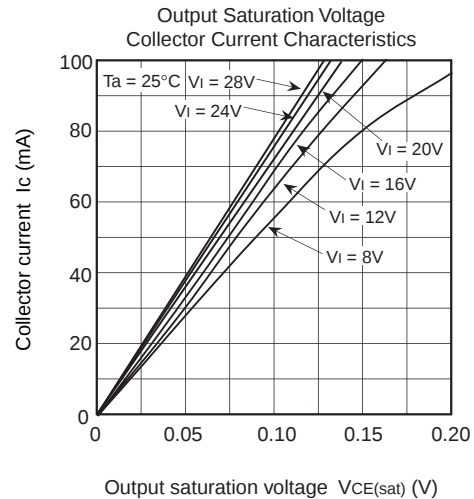
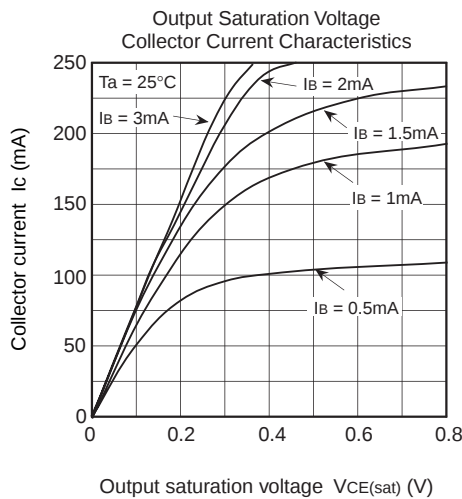
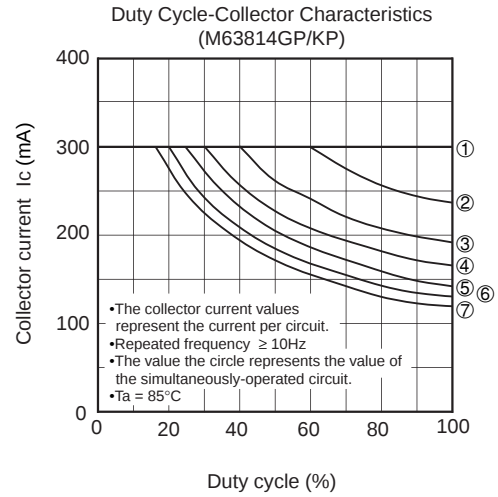
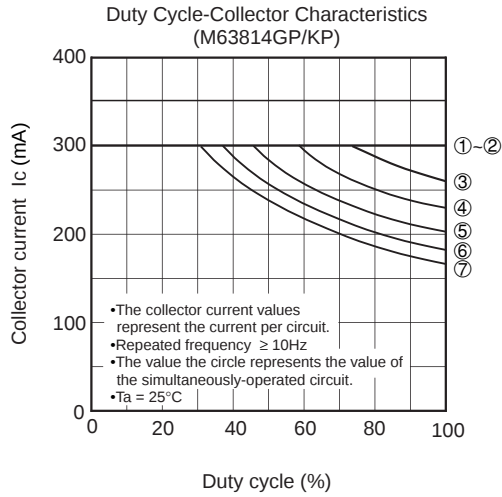
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TYPICAL CHARACTERISTICS



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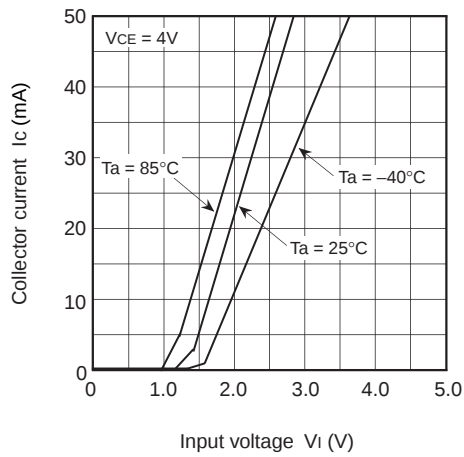
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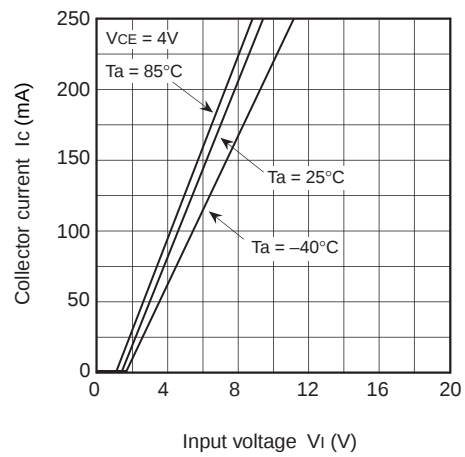
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Grounded Emitter Transfer Characteristics



Grounded Emitter Transfer Characteristics



Clamping Diode Characteristics

